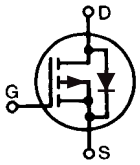
IXYS

TrenchP™ Power MOSFET

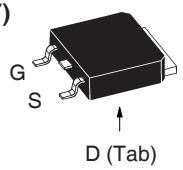
IXTY48P05T
IXTA48P05T
IXTP48P05T

V_{DSS} = - 50V
I_{D25} = - 48A
$R_{DS(on)}$ ≤ 30mΩ

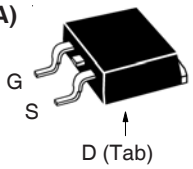
P-Channel Enhancement Mode
Avalanche Rated



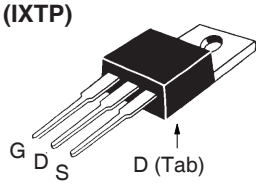
TO-252 (IXTY)



TO-263 (IXTA)



TO-220 (IXTP)



G = Gate D = Drain
S = Source Tab = Drain

Symbol	Test Conditions	Maximum Ratings	
V_{DSS}	T_J = 25°C to 150°C	- 50	V
V_{DGR}	T_J = 25°C to 150°C, R_{GS} = 1MΩ	- 50	V
V_{GSS}	Continuous	±15	V
V_{GSM}	Transient	±25	V
I_{D25}	T_C = 25°C	- 48	A
I_{DM}	T_C = 25°C, Pulse Width Limited by T_{JM}	-150	A
I_A	T_C = 25°C	- 48	A
E_{AS}	T_C = 25°C	300	mJ
P_D	T_C = 25°C	150	W
T_J		-55 ... +150	°C
T_{JM}		150	°C
T_{stg}		-55 ... +150	°C
T_L	Maximum Lead Temperature for Soldering	300	°C
T_{SOLD}	1.6 mm (0.062in.) from Case for 10s	260	°C
M_d	Mounting Torque (TO-220)	1.13 / 10	Nm/lb.in
Weight	TO-252	0.35	g
	TO-263	2.50	g
	TO-220	3.00	g

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
BV_{DSS}	V_{GS} = 0V, I_D = - 250μA	- 50			V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, I_D = - 250μA	- 2.0		- 4.5	V
I_{GSS}	V_{GS} = ±15V, V_{DS} = 0V			±50	nA
I_{DSS}	$V_{DS} = V_{DSS}$, V_{GS} = 0V			- 10	μA
	T_J = 125°C			- 250	μA
$R_{DS(on)}$	V_{GS} = -10V, I_D = 0.5 • I_{D25}, Note 1			30	mΩ

Features

- International Standard Packages
- Avalanche Rated
- Extended FBSOA
- Fast Intrinsic Diode
- Low $R_{DS(ON)}$ and Q_G

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- High-Side Switching
- Push Pull Amplifiers
- DC Choppers
- Automatic Test Equipment
- Current Regulators
- Battery Charger Applications

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Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
g_{fs}	V_{DS} = -10V, I_D = 0.5 • I_{D25}, Note 1	16	26		S
C_{iss}	V_{GS} = 0V, V_{DS} = - 25V, f = 1MHz		3660		pF
C_{oss}			495		pF
C_{rss}			215		pF
$t_{d(on)}$	**Resistive Switching Times**		20		ns
t_r	V_{GS} = -10V, V_{DS} = - 30V, I_D = 0.5 • I_{D25}		15		ns
$t_{d(off)}$	R_G = 3Ω (External)		30		ns
t_f			13		ns
$Q_{g(on)}$	V_{GS} = -10V, V_{DS} = 0.5 • V_{DSS}, I_D = 0.5 • I_{D25}		53		nC
Q_{gs}			16		nC
Q_{gd}			21		nC
R_{thJC}				0.83	°C/W
R_{thCS}	TO-220		0.50		°C/W

Source-Drain Diode

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
I_S	V_{GS} = 0V			- 48	A
I_{SM}	Repetitive, Pulse Width Limited by T_{JM}			-192	A
V_{SD}	I_F = I_S, V_{GS} = 0V, Note 1			-1.5	V
t_{rr}	I_F = 0.5 • I_{D25}, -di/dt = -100A/μs		30		ns
Q_{RM}	V_R = - 25V, V_{GS} = 0V		43.4		nC
I_{RM}			- 2.8		A

Note 1: Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,860,072 4,881,106 4,931,844 5,017,508 5,034,796 5,049,961 5,063,307 5,187,117 5,237,481 5,381,025 5,486,715 6,162,665 6,259,123B1 6,306,728B1 6,404,065B1 6,534,343 6,583,505 6,683,344 6,710,405B2 6,710,463 6,727,585 6,759,692 6,771,478B2 7,005,734B2 7,063,975B2 7,071,537 7,157,338B2

Fig. 1. Output Characteristics @ T_J = 25°C

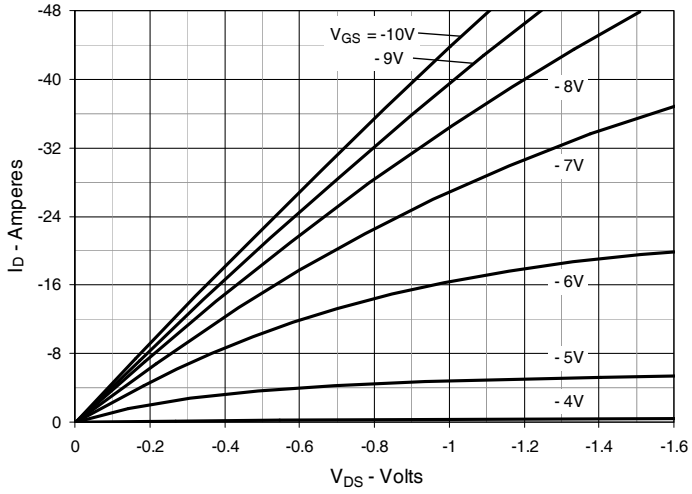

Fig. 2. Extended Output Characteristics @ T_J = 25°C

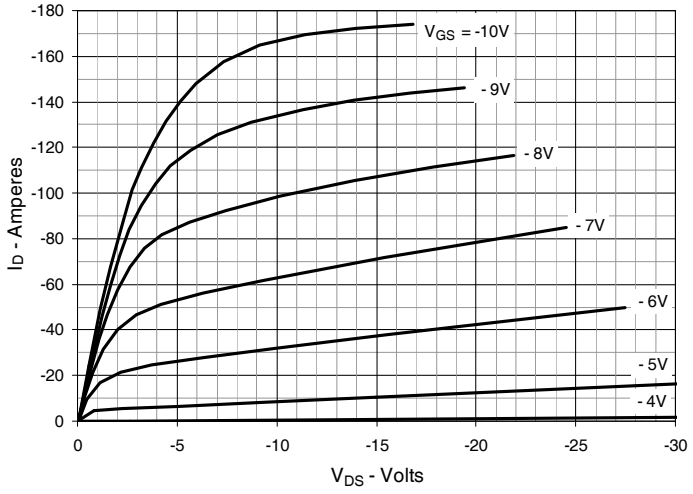

Fig. 3. Output Characteristics @ T_J = 125°C

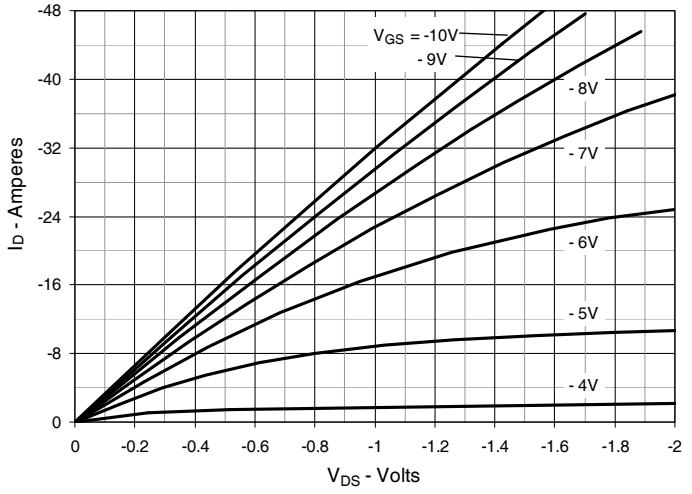

Fig. 4. $R_{DS(on)}$ Normalized to I_D = - 24A Value vs. Junction Temperature

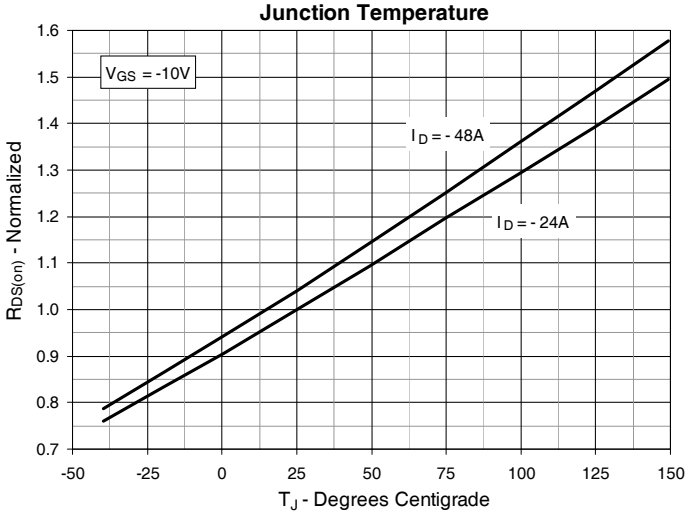

Fig. 5. $R_{DS(on)}$ Normalized to I_D = - 24A Value vs. Drain Current

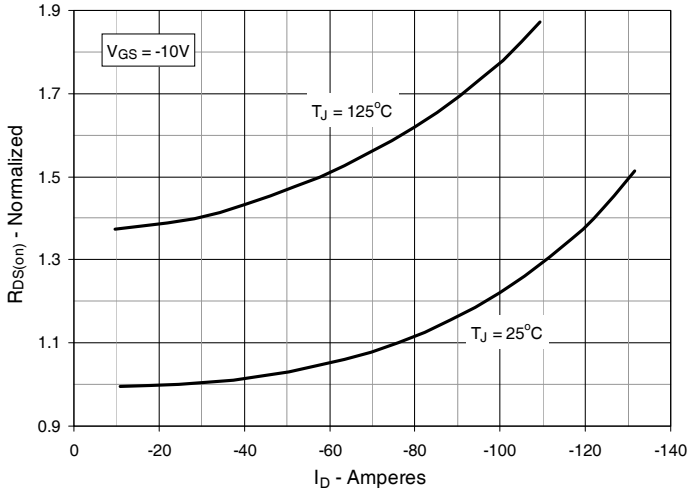

Fig. 6. Maximum Drain Current vs. Case Temperature

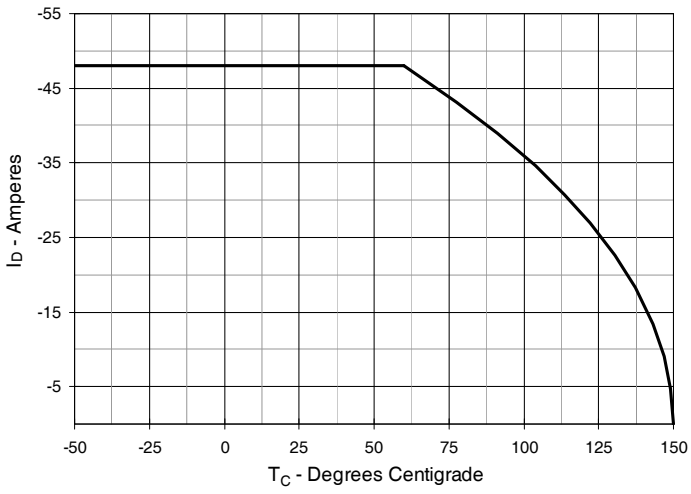

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Fig. 7. Input Admittance

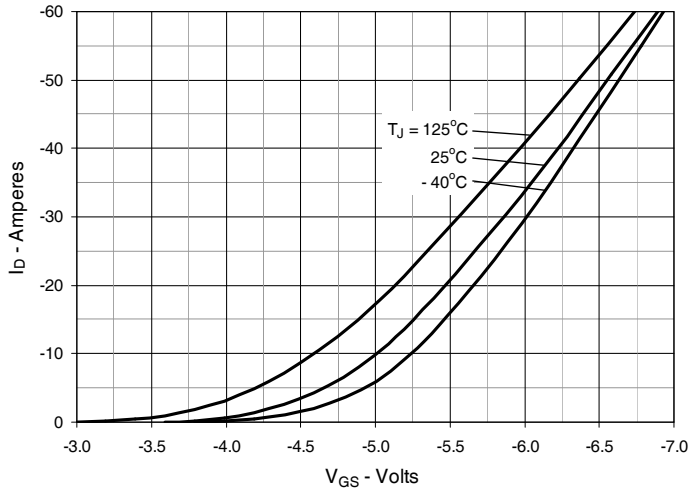

Fig. 8. Transconductance

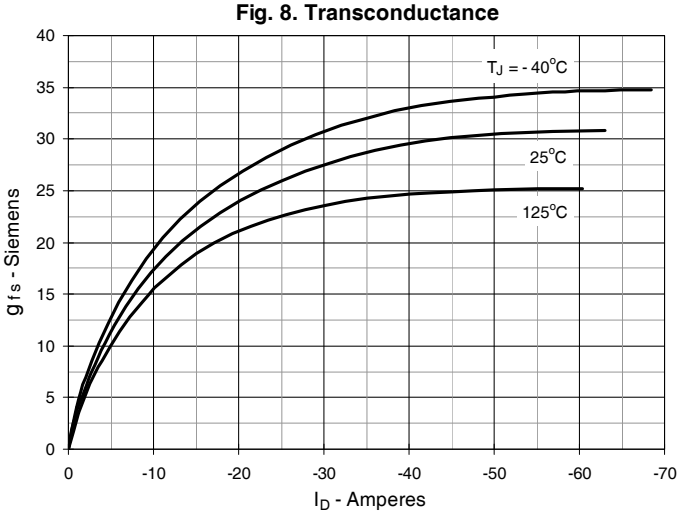

Fig. 9. Forward Voltage Drop of Intrinsic Diode

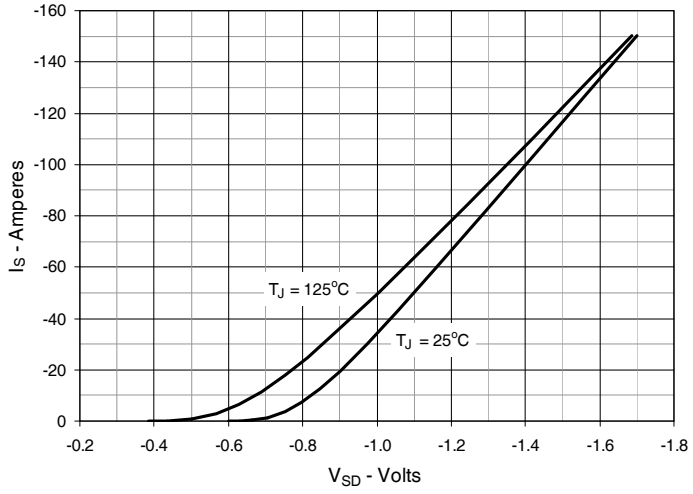

Fig. 10. Gate Charge

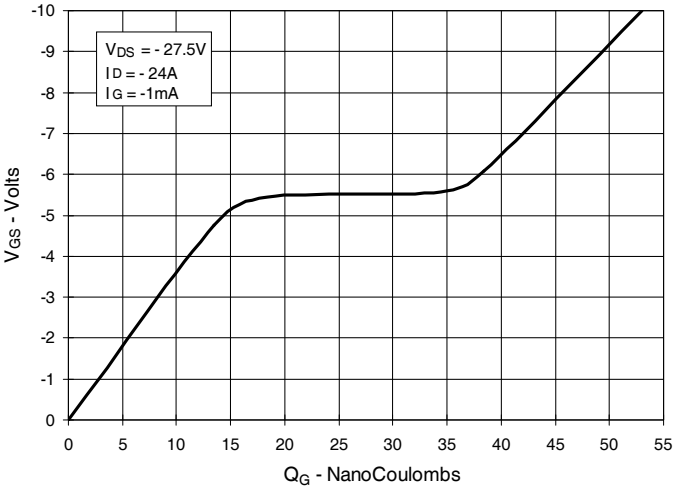

Fig. 11. Capacitance

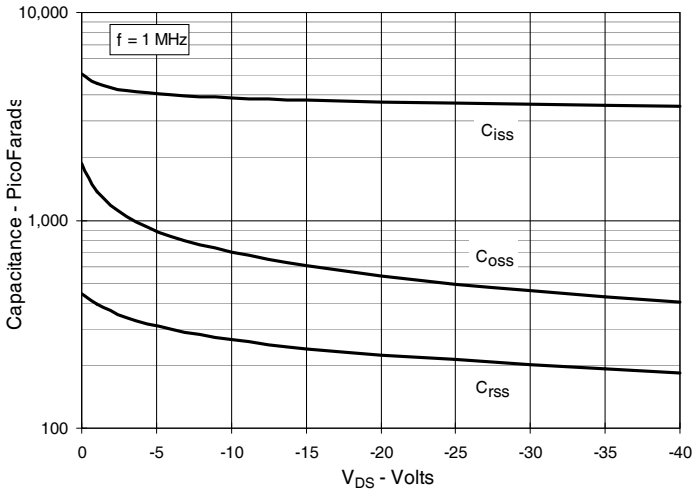

Fig. 12. Forward-Bias Safe Operating Area

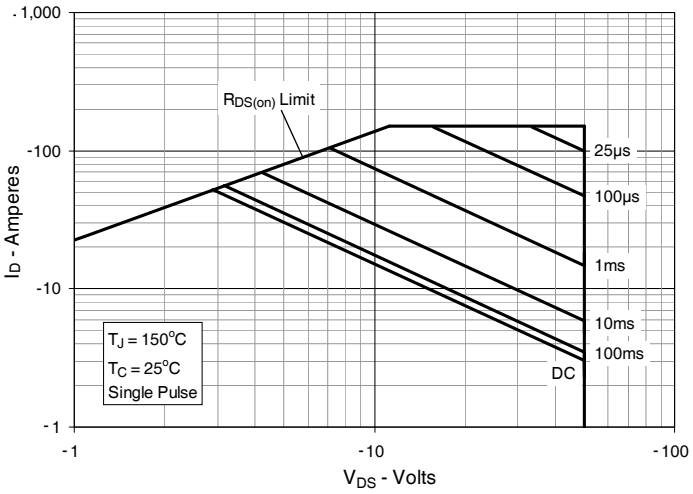

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Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

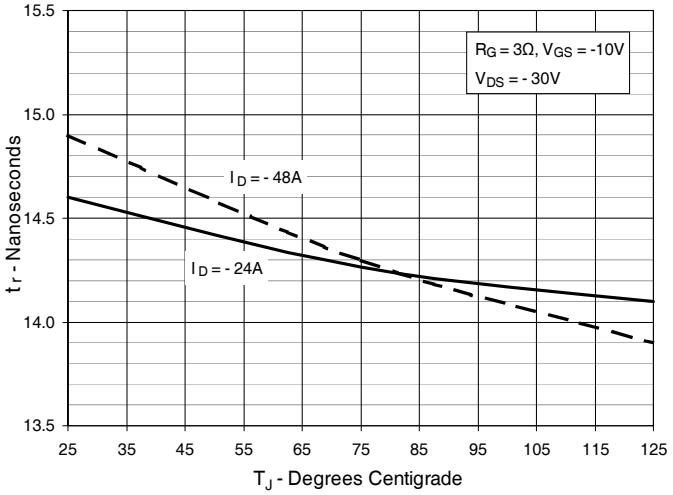

Fig. 14. Resistive Turn-on Rise Time vs. Drain Current

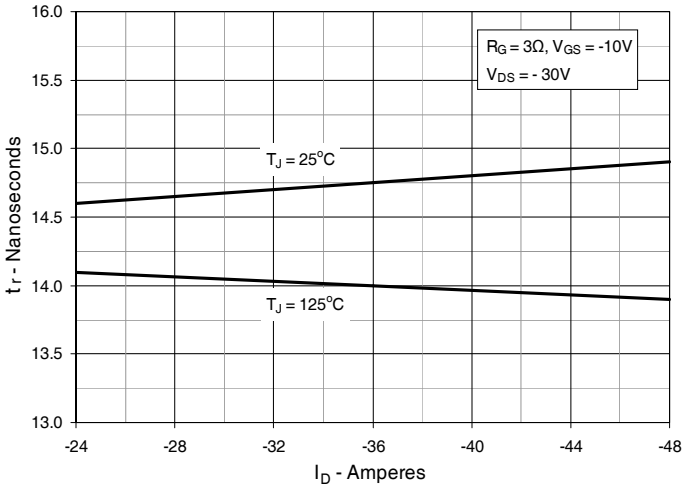

Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

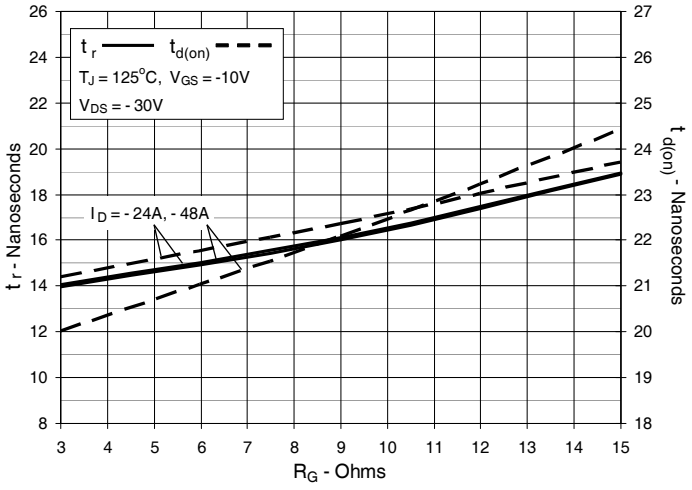

Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

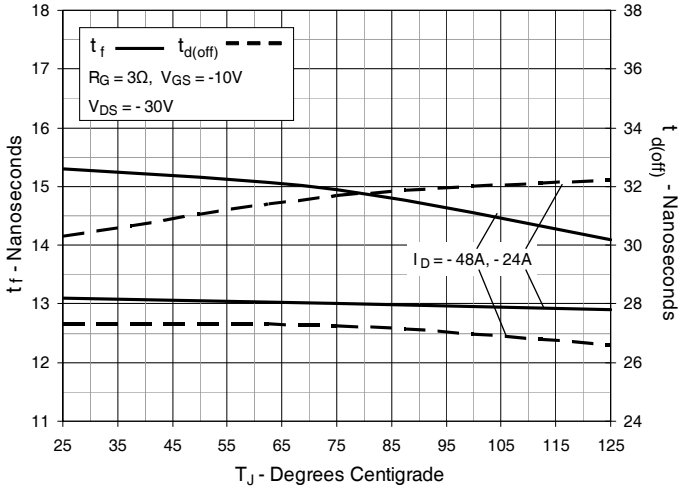

Fig. 17. Resistive Turn-off Switching Times vs. Drain Current

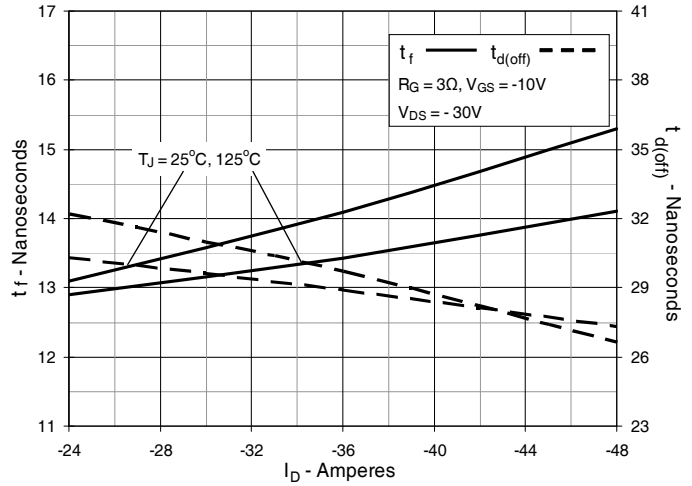

Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance

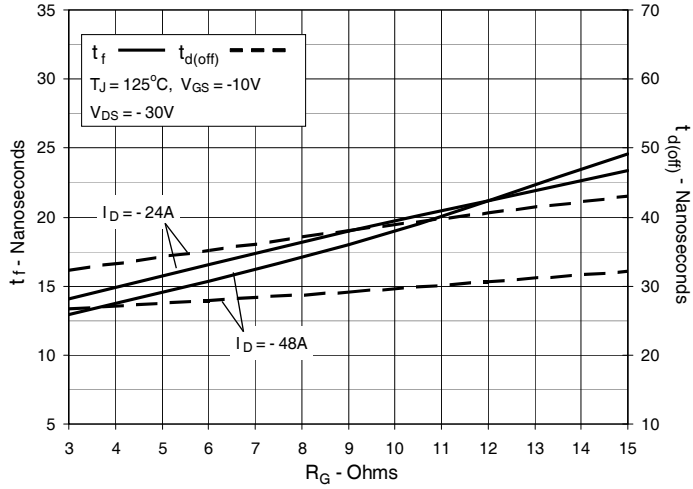

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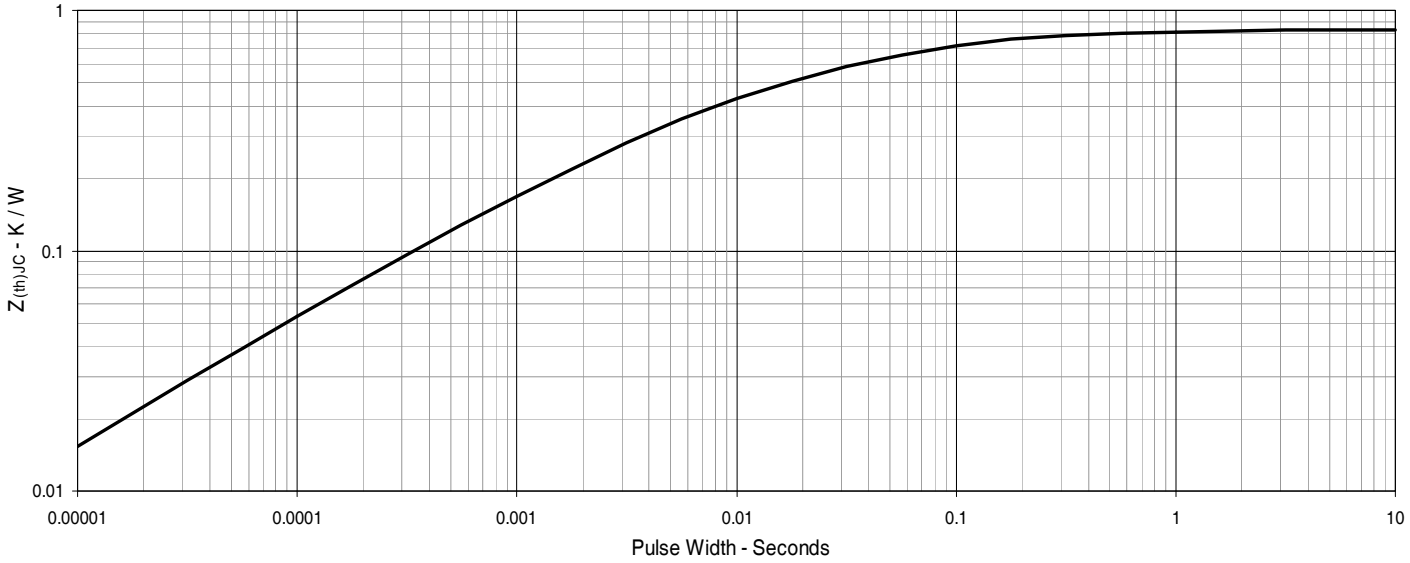
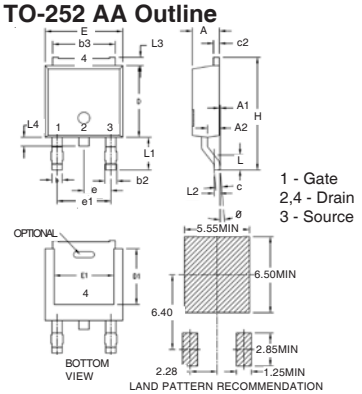
Fig. 19. Maximum Transient Thermal Impedance

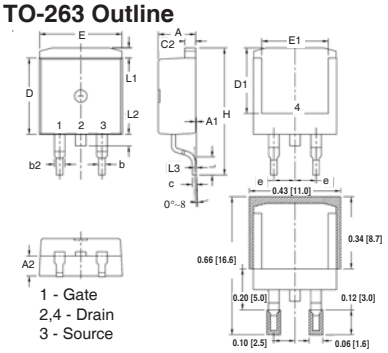


TO-252 AA Outline



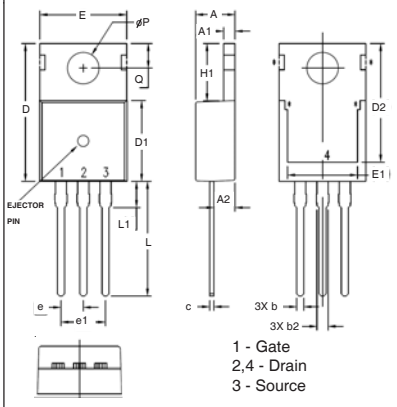
SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.086	.094	2.19	2.38
A1	0	.005	0	0.12
A2	.038	.046	0.97	1.17
b	.025	.035	0.64	0.89
b2	.030	.045	0.76	1.14
b3	.200	.215	5.08	5.46
c	.018	.024	0.46	0.61
c2	.018	.023	0.46	0.58
D	.235	.245	5.97	6.22
D1	.180	.205	4.57	5.21
E	.250	.265	6.35	6.73
E1	.170	.205	4.32	5.21
e	.090 BSC		2.28 BSC	
e1	.180 BSC		4.57 BSC	
H	.370	.410	9.40	10.42
L	.055	.070	1.40	1.78
L1	.100	.115	2.54	2.92
L2	.020 BSC		0.50 BSC	
L3	.025	.040	0.64	1.02
L4	.025	.040	0.64	1.02
θ	0°	10°	0°	10°

TO-263 Outline



SYM	INCHES		MILLIMETER	
	MIN	MAX	MIN	MAX
A	.170	.185	4.30	4.70
A1	.000	.008	0.00	0.20
A2	.091	.098	2.30	2.50
b	.028	.035	0.70	0.90
b2	.046	.060	1.18	1.52
C	.018	.024	0.45	0.60
C2	.049	.060	1.25	1.52
D	.340	.370	8.63	9.40
D1	.300	.327	7.62	8.30
E	.380	.410	9.65	10.41
E1	.270	.330	6.86	8.38
e	.100 BSC		2.54 BSC	
H	.580	.620	14.73	15.75
L	.075	.105	1.91	2.67
L1	.039	.060	1.00	1.52
L2	—	.070	—	1.77
L3	.010 BSC		0.254 BSC	

TO-220 Outline



SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.169	.185	4.30	4.70
A1	.047	.055	1.20	1.40
A2	.079	.106	2.00	2.70
b	.024	.039	0.60	1.00
b2	.045	.057	1.15	1.45
c	.014	.026	0.35	0.65
D	.587	.626	14.90	15.90
D1	.335	.370	8.50	9.40
(D2)	.500	.531	12.70	13.50
E	.382	.406	9.70	10.30
(E1)	.283	.323	7.20	8.20
e	.100 BSC		2.54 BSC	
e1	.200 BSC		5.08 BSC	
H1	.244	.268	6.20	6.80
L	.492	.547	12.50	13.90
L1	.110	.154	2.80	3.90
ØP	.134	.150	3.40	3.80
Q	.106	.126	2.70	3.20

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